

STGB7NB60HD

N-CHANNEL 7A - 600V DPAK PowerMESHTM IGBT

TYPE	V _{CES}	V _{CES} V _{CE(sat)}	
STGB7NB60HD	600 V	< 2.8 V	7 A

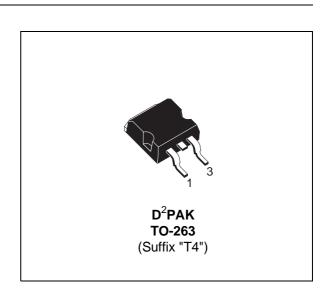
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- LOW ON-VOLTAGE DROP (V_{cesat})
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- VERY HIGH FREQUENCY OPERATION
- OFF LOSSES INCLUDE TAIL CURRENT
- CO-PACKAGED WITH TURBOSWITCH™ ANTIPARALLEL DIODE
- SURFACE-MOUNTING D²PAK (TO-263) POWER PACKAGE IN TAPE & REEL (SUFFIX "T4")

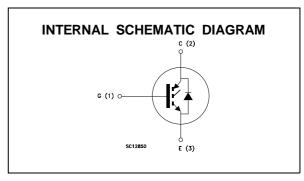


Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding perfomances. The suffix "H" identifies a family optimized to achieve very low switching times for high frequency applications (<120kHz).

APPLICATIONS

- HIGH FREQUENCY MOTOR CONTROLS
- SMPS AND PFC IN BOTH HARD SWITCH AND RESONANT TOPOLOGIES





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V
V_{GE}	Gate-Emitter Voltage	± 20	V
I _C	Collector Current (continuous) at T _c = 25 °C	14	Α
Ic	Collector Current (continuous) at T _c = 100 °C	7	Α
I _{CM} (●)	Collector Current (pulsed)	56	Α
P_{tot}	Total Dissipation at T _c = 25 °C	80	W
	Derating Factor	0.64	W/°C
T_{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

(•) Pulse width limited by safe operating area

June 1999 1/8

THERMAL DATA

R _{thj-c}	Thermal Resistance Junction-case	Max	1.56	°C/W
R _{thj-a}	Thermal Resistance Junction-ambient	Max	62.5	°C/W
R _{thc-s}	Thermal Resistance Case-sink	Тур	0.5	°C/W

ELECTRICAL CHARACTERISTICS ($T_j = 25$ °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-Emitter Breakdown Voltage	$I_C = 250 \ \mu A$ $V_{GE} = 0$	600			V
I _{CES}	Collector cut-off (V _{GE} = 0)	$V_{CE} = Max Rating$ $T_j = 25 ^{\circ}C$ $V_{CE} = Max Rating$ $T_j = 125 ^{\circ}C$			250 2000	μA μA
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	$V_{GE} = \pm 20 \text{ V}$ $V_{CE} = 0$			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GE(th)}	Gate Threshold Voltage	$V_{CE} = V_{GE}$ $I_C = 250 \mu A$	3		5	V
V _{CE} (SAT)		$V_{GE} = 15 \text{ V}$ $I_{C} = 7 \text{ A}$ $V_{GE} = 15 \text{ V}$ $I_{C} = 7 \text{ A}$ $T_{j} = 125 ^{\circ}\text{C}$		2.3 1.9	2.8	V V

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
G fs	Forward Transconductance	V _{CE} =25 V I _C = 7 A	3.5	5		S
Cies Coes Cres	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{CE} = 25 V f = 1 MHz V _{GE} = 0	390 45 10	560 68 15	730 90 20	pF pF pF
Q _G Q _{GE} Q _{GC}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	V _{CE} = 480 V I _C = 7 A V _{GE} = 15 V		42 7.9 17.6	55	nC nC nC
I _{CL}	Latching Current	$V_{clamp} = 480 \text{ V} R_G = 10\Omega$ $T_j = 150 \text{ °C}$	28			Α

SWITCHING ON

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Delay Time Rise Time	V _{CC} = 480 V V _{GE} = 15 V	$I_C = 7 A$ $R_G = 10\Omega$		15 48		ns ns
(di/dt) _{on}	Turn-on Current Slope	$V_{CC} = 480 \text{ V}$ $R_G = 10 \Omega$	$I_C = 7 A$ $V_{GE} = 15 V$		160		A/μs
E _{on} (o)	Turn-on Switching Losses	$T_j = 125$ °C			185		μJ

ELECTRICAL CHARACTERISTICS (continued)

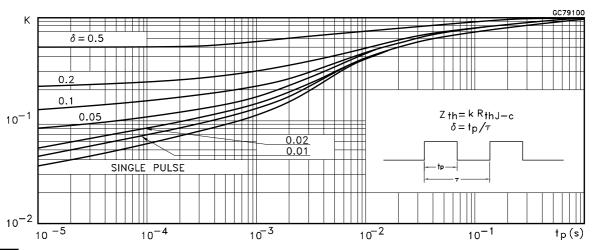
SWITCHING OFF

Symbol	Parameter	Test Con	ditions	Min.	Тур.	Max.	Unit
tc	Cross-Over Time	VCC = 480 V	$I_C = 7 A$		85		ns
$t_r(v_{off})$	Off Voltage Rise Time	$R_{GE} = 10 \Omega$	$V_{GE} = 15 \text{ V}$		20		ns
t _d (off)	Delay Time				75		ns
t _f	Fall Time				70		ns
E _{off} (**)	Turn-off Switching Loss				85		μJ
E _{ts} (◌)	Total Switching Loss				235		μJ
tc	Cross-Over Time	VCC = 480 V	I _C = 7 A		150		ns
$t_r(v_{off})$	Off Voltage Rise Time	$R_{GE} = 10 \Omega$	$V_{GE} = 15 \text{ V}$		50		ns
t _d (off)	Delay Time	T _j = 125 °C			110		ns
t _f	Fall Time				110		ns
E _{off} (**)	Turn-off Switching Loss				220		μJ
E _{ts} (○)	Total Switching Loss				405		μJ

COLLECTOR-EMITTER DIODE

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _f I _{fm}	Forward Current Forward Current pulsed					7 56	A A
V _f	Forward On-Voltage	I _f = 7 A I _f = 7 A	T _j = 125 °C		1.6 1.4	2.0	V V
t _{rr} Q _{rr} I _{rrm}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_f = 7 \text{ A}$ $dI/dt = 100 \text{ A/}\mu\text{S}$	V _R =200 V T _j = 125 °C		100 180 3.6		ns nC A

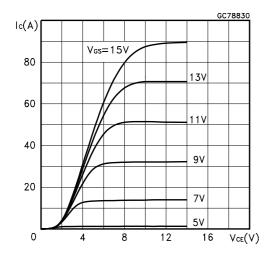
Thermal Impedance



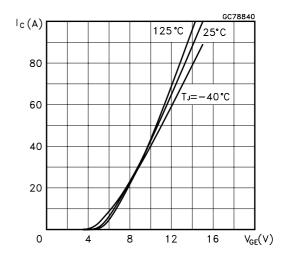
⁽e) Pulse width limited by max. junction temperature
(c) Include recovery losses on the STTA506 freewheeling diode

^(*) Pulsed: Pulse duration = $300 \,\mu s$, duty cycle 1.5 % (**)Losses Include Also The Tail (Jedec Standardization)

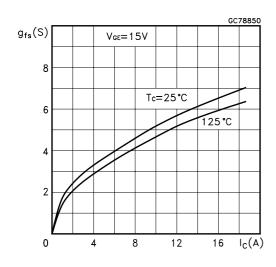
Output Characteristics



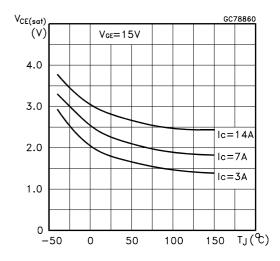
Transfer Characteristics



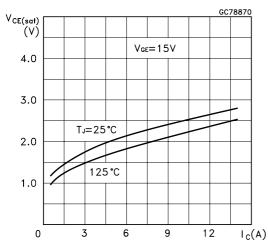
Transconductance



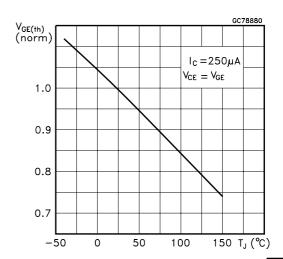
Collector-Emitter On Voltage vs Temperature



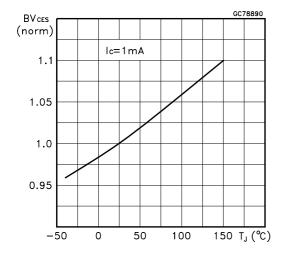
Collector-Emitter On Voltage vs Collector Current



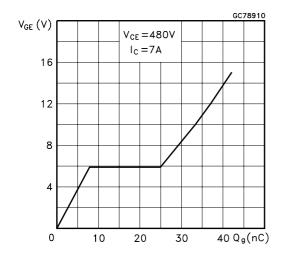
Gate Threshold vs Temperature



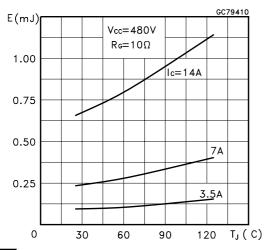
Normalized Breakdown Voltage vs Temperature



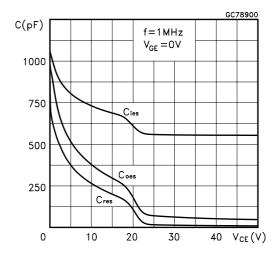
Gate Charge vs Gate-Emitter Voltage



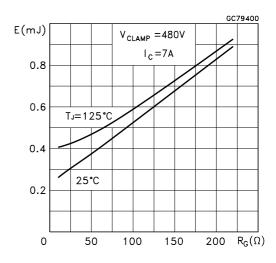
Total Switching Losses vs Temperature



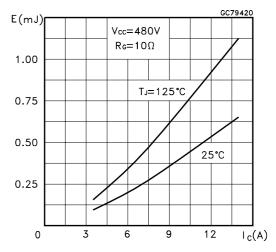
Capacitance Variations



Total Switching Losses vs Gate Resistance



Total Switching Losses vs Collector Current



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Switching Off Safe Operating Area

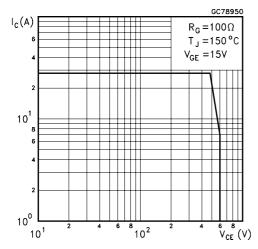


Fig. 1: Gate Charge test Circuit

Diode Forward Voltage

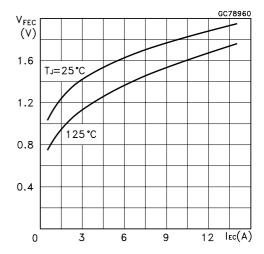
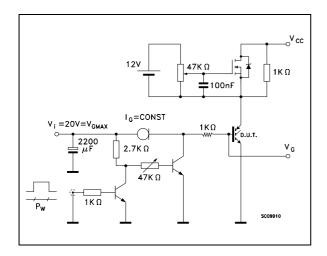


Fig. 2: Test Circuit For Inductive Load Switching



A Δ A

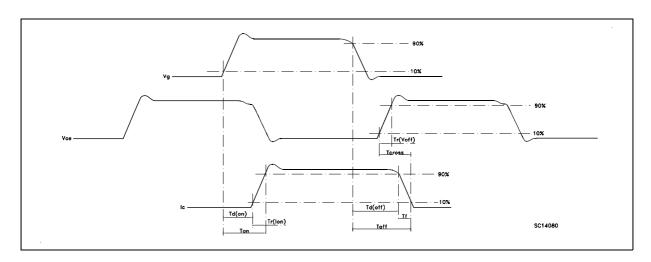
FAST DIODE

B 9 B

D.U.T.

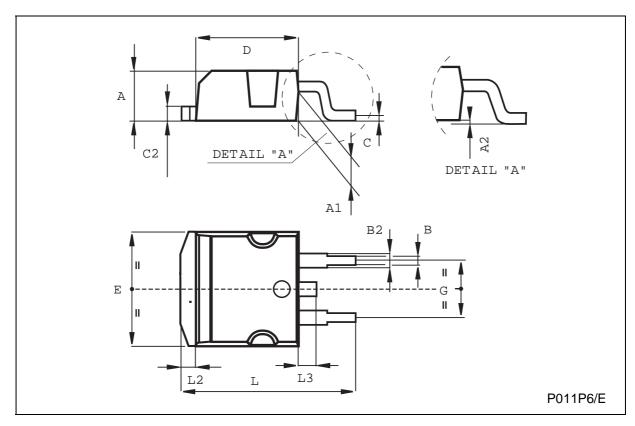
SC09920

Fig. 3: Switching Waveforms



TO-263 (D²PAK) MECHANICAL DATA

DIM.		mm				
Dim.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
В	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
С	0.45		0.6	0.017		0.023
C2	1.21		1.36	0.047		0.053
D	8.95		9.35	0.352		0.368
Е	10		10.4	0.393		0.409
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.624
L2	1.27		1.4	0.050		0.055
L3	1.4		1.75	0.055		0.068



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